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NX3L1T53 Low-ohmic single-pole double-throw analog switch Rev. 8 – 23 January 2013 Product data sheet

### 1. General description

The NX3L1T53 is a low-ohmic single-pole double-throw analog switch suitable for use as an analog or digital 2:1 multiplexer/demultiplexer. It has a digital select input (S), two independent inputs/outputs (Y0 and Y1), a common input/output (Z) and an active LOW enable input ( $\overline{E}$ ). When pin  $\overline{E}$  is HIGH, the switch is turned off.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I<sub>CC</sub>. This makes it possible for the NX3L1T53 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L1T53 allows signals with amplitude up to V<sub>CC</sub> to be transmitted from Z to Y0 or Y1; or from Y0 or Y1 to Z. It's low ON resistance (0.5  $\Omega$ ) and flatness (0.13  $\Omega$ ) ensures minimal attenuation and distortion of transmitted signals.

### 2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
  - 1.6  $\Omega$  (typical) at V<sub>CC</sub> = 1.4 V
  - 1.0  $\Omega$  (typical) at V<sub>CC</sub> = 1.65 V
  - 0.55  $\Omega$  (typical) at V<sub>CC</sub> = 2.3 V
  - 0.50  $\Omega$  (typical) at V<sub>CC</sub> = 2.7 V
  - 0.50  $\Omega$  (typical) at V<sub>CC</sub> = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 7500 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
  - IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- 1.8 V control logic at  $V_{CC} = 3.6 V$
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V<sub>CC</sub>
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



# 3. Applications

- Cell phone
- PDA
- Portable media player

# 4. Ordering information

### Table 1. Ordering information

Type number	Package	Package								
	Temperature range	Name	Description	Version						
NX3L1T53GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm	SOT833-1						
NX3L1T53GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm	SOT996-2						
NX3L1T53GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6 \times 1.6 \times 0.5$ mm	SOT902-2						

### 5. Marking

### Table 2. Marking codes<sup>[1]</sup>

Type number	Marking code
NX3L1T53GT	M53
NX3L1T53GD	M53
NX3L1T53GM	M53

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

Low-ohmic single-pole double-throw analog switch

# 6. Functional diagram

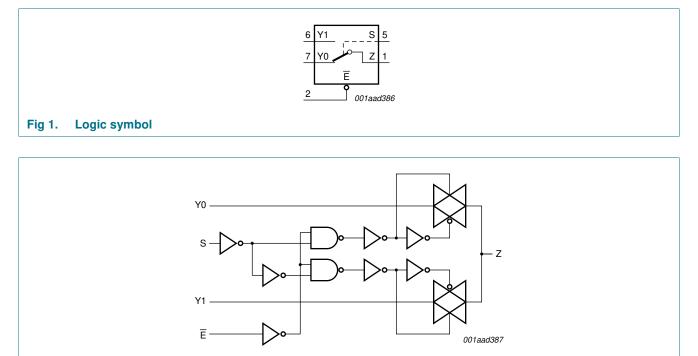
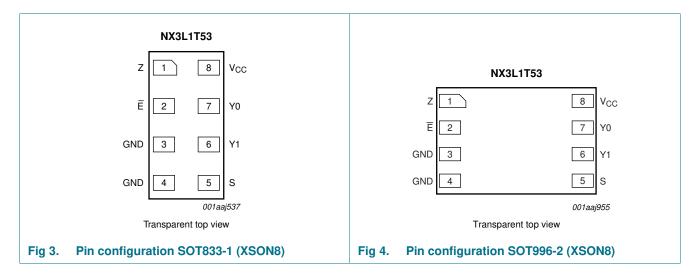


Fig 2. Logic diagram

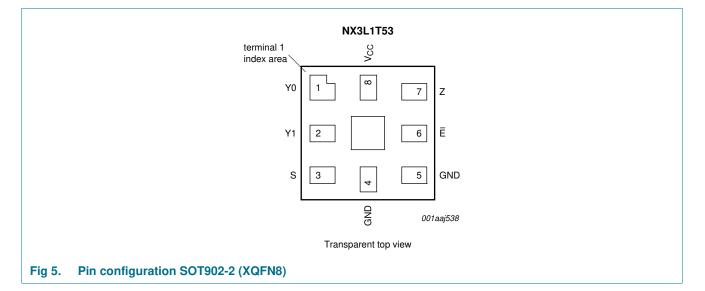
# 7. Pinning information

### 7.1 Pinning



# NX3L1T53

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### 7.2 Pin description

Symbol	Pin		Description
	SOT833-1 and SOT996-2	SOT902-2	
Z	1	7	common output or input
Ē	2	6	enable input (active LOW)
GND	3	5	ground (0 V)
GND	4	4	ground (0 V)
S	5	3	select input
Y1	6	2	independent input or output
Y0	7	1	independent input or output
V <sub>CC</sub>	8	8	supply voltage

# 8. Functional description

### Table 4.Function table<sup>[1]</sup>

Input		Channel on
S	Ē	
L	L	Y0 to Z or Z to Y0
Н	L	Y1 to Z or Z to Y1
Х	Н	switch off

 $[1] \quad H = HIGH \text{ voltage level}; L = LOW \text{ voltage level}; X = don't \text{ care}.$ 

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### 9. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage	select input S and enable input $\overline{E}$	<u>[1]</u> –0.5	+4.6	V
V <sub>SW</sub>	switch voltage		[2] -0.5	$V_{CC} + 0.5$	V
I <sub>IK</sub>	input clamping current	$V_{l} < -0.5 V$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V	-	±50	mA
I <sub>SW</sub>	switch current	$V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; source or sink current	-	±350	mA
		V <sub>SW</sub> > -0.5 V or V <sub>SW</sub> < V <sub>CC</sub> + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3] _	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For XSON8 and XQFN8 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

### **10. Recommended operating conditions**

#### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage			1.4	-	4.3	V
VI	input voltage	select input S and enable input $\overline{E}$		0	-	4.3	V
$V_{SW}$	switch voltage		[1]	0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature			-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 1.4 \text{ V} \text{ to } 4.3 \text{ V}$	[2]	-	-	200	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

# 11. Static characteristics

### Table 7. Static characteristics

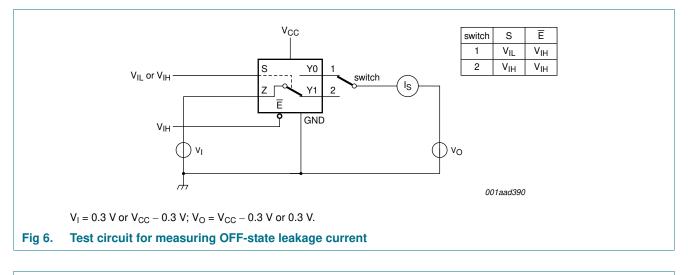
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

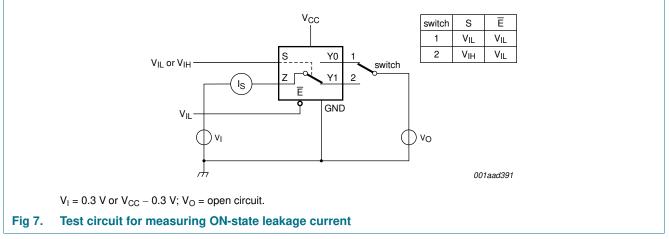
Symbol	Parameter	Conditions	Τ <sub>ε</sub>	<sub>mb</sub> = 25	°C	T <sub>amb</sub> =	T <sub>amb</sub> = -40 °C to +125 °C		
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.4 V to 1.6 V	0.9	-	-	0.9	-	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	V
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	1.1	-	-	1.1	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	1.3	-	-	1.3	-	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	1.4	-	-	1.4	-	-	V
V <sub>IL</sub>	LOW-level	$V_{CC} = 1.4 \text{ V}$ to 1.6 V	-	-	0.3	-	0.3	0.3	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.5	-	0.5	0.5	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	0.6	-	0.6	0.6	V
I	input leakage current	select input S and enable input $\overline{E}$ ; V <sub>I</sub> = GND to 4.3 V; V <sub>CC</sub> = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μA
I <sub>S(OFF)</sub> OFF-state leakage current		Y0 and Y1 port; see <u>Figure 6</u>							
	current	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nA
S(ON)	ON-state	Z port; see Figure 7							
	leakage	$V_{CC} = 1.4 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
	current	$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nA
СС	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or $V_{CC}$							
		$V_{CC} = 3.6 V$	-	-	100	-	690	6000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	7000	nA
∆l <sub>CC</sub>	additional	$V_{SW} = GND \text{ or } V_{CC}$							
	supply current	$V_1 = 2.6 V; V_{CC} = 4.3 V$	-	2.0	4.0	-	7	7	μA
		$V_1 = 2.6 V; V_{CC} = 3.6 V$	-	0.35	0.7	-	1	1	μA
		$V_{I} = 1.8 V; V_{CC} = 4.3 V$	-	7.0	10.0	-	15	15	μA
		$V_{I} = 1.8 V; V_{CC} = 3.6 V$	-	2.5	4.0	-	5	5	μA
		$V_{I} = 1.8 V; V_{CC} = 2.5 V$	-	50	200	-	300	500	nA
Cı	input capacitance		-	1.0	-	-	-	-	pF
C <sub>S(OFF)</sub>	OFF-state capacitance		-	35	-	-	-	-	pF
C <sub>S(ON)</sub>	ON-state capacitance		-	130	-	-	-	-	pF

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### Low-ohmic single-pole double-throw analog switch

### 11.1 Test circuits





### 11.2 ON resistance

#### Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 9 to Figure 15.

	1 0		10	,,	0 /			
Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	+125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
R <sub>ON(peak)</sub> (	ON resistance (peak)	$V_I = GND$ to $V_{CC}$ ; $I_{SW} = 100 \text{ mA}$ ; see <u>Figure 8</u>						
		$V_{CC} = 1.4 V$	-	1.6	3.7	-	4.1	Ω
		V <sub>CC</sub> = 1.65 V	-	1.0	1.6	-	1.7	Ω
		$V_{CC} = 2.3 V$	-	0.55	0.8	-	0.9	Ω
		$V_{CC} = 2.7 V$	-	0.5	0.75	-	0.9	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.75	-	0.9	Ω

# **NX3L1T53**

### Low-ohmic single-pole double-throw analog switch

Symbol	Parameter	Conditions		–40 °C to +85 °C		5 °C	–40 °C to	+125 °C	Unit
			N	/lin	Typ <mark>[1]</mark>	Max	Min	Max	
$\Delta R_{ON}$	ON resistance mismatch between channels	$V_I = GND$ to $V_{CC}$ ; $I_{SW} = 100 \text{ mA}$	[2]						·
		$V_{CC} = 1.4 V$		-	0.04	0.3	-	0.3	Ω
		V <sub>CC</sub> = 1.65 V		-	0.04	0.2	-	0.3	Ω
		$V_{CC} = 2.3 V$		-	0.02	0.08	-	0.1	Ω
		$V_{CC} = 2.7 V$		-	0.02	0.075	-	0.1	Ω
		$V_{CC} = 4.3 V$		-	0.02	0.075	-	0.1	Ω
$R_{ON(flat)}$	ON resistance (flatness)	$V_I = GND$ to $V_{CC}$ ; $I_{SW} = 100 \text{ mA}$	<u>[3]</u>						
		$V_{CC} = 1.4 V$		-	1.0	3.3	-	3.6	Ω
		V <sub>CC</sub> = 1.65 V		-	0.5	1.2	-	1.3	Ω
		V <sub>CC</sub> = 2.3 V		-	0.15	0.3	-	0.35	Ω
		V <sub>CC</sub> = 2.7 V		-	0.13	0.3	-	0.35	Ω
		$V_{CC} = 4.3 V$		-	0.2	0.4	-	0.45	Ω

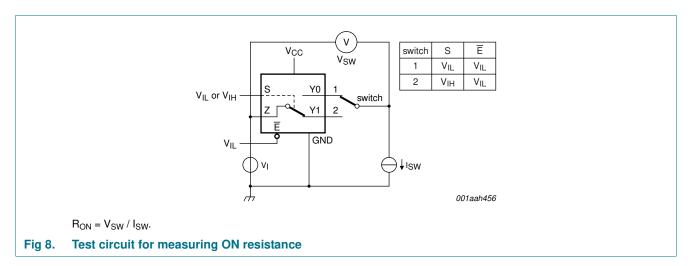
#### Table 8. **ON resistance** ... continued

[1] Typical values are measured at  $T_{amb} = 25 \ ^{\circ}C$ .

Measured at identical  $V_{CC}$ , temperature and input voltage. [2]

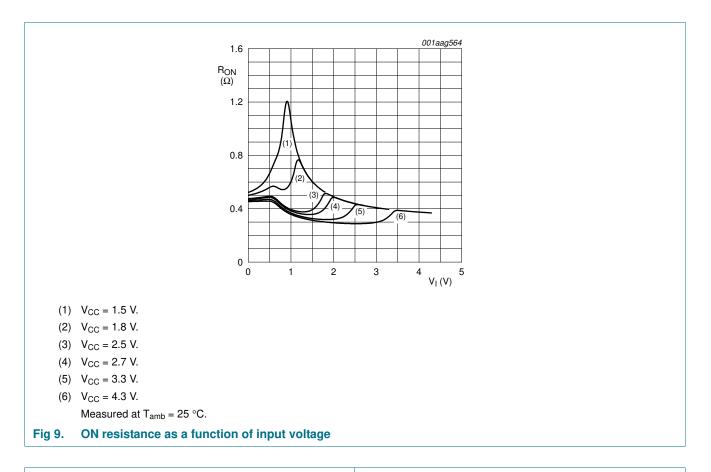
[3] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

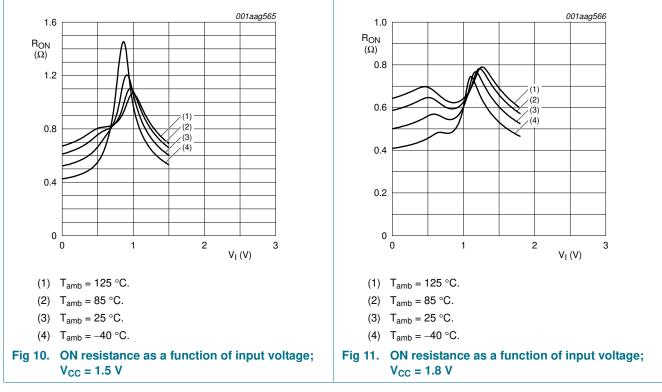
### 11.3 ON resistance test circuit and waveforms



# NX3L1T53

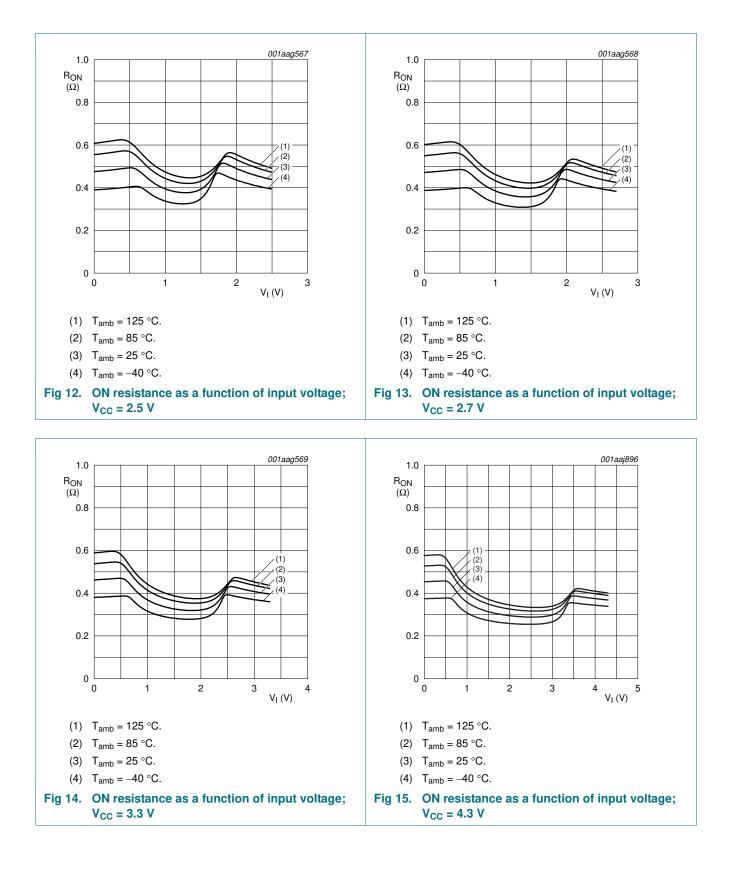
#### Low-ohmic single-pole double-throw analog switch





# NX3L1T53

### Low-ohmic single-pole double-throw analog switch



# **12. Dynamic characteristics**

#### Table 9. Dynamic characteristics

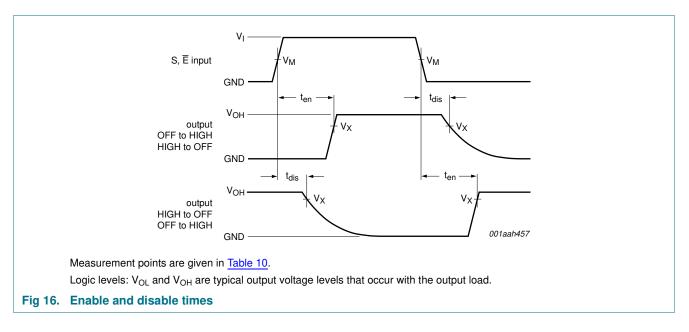
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 18.

Symbol	Parameter	Conditions		25 °C		-40	°C to +12	5 °C	Unit
			Min	Typ[1]	Мах	Min	Max (85 °C)	Max (125 °C)	
t <sub>en</sub>	enable time	S or Ē to Z or Yn; see <u>Figure 16</u>							
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	50	90	-	120	120	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	36	70	-	80	90	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	24	45	-	50	55	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	22	40	-	45	50	ns
		$V_{CC}$ = 3.6 V to 4.3 V	-	22	40	-	45	50	ns
t <sub>dis</sub>	disable time	S or Ē to Z or Yn; see <u>Figure 16</u>							
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	32	70	-	80	90	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	20	55	-	60	65	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	12	25	-	30	35	ns
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	10	20	-	25	30	ns
		$V_{CC}$ = 3.6 V to 4.3 V	-	10	20	-	25	30	ns
t <sub>b-m</sub>	break-before-make	see Figure 17	2]						
	time	$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	19	-	9	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V	-	17	-	7	-	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V	-	13	-	4	-	-	ns
		$V_{CC}$ = 2.7 V to 3.6 V	-	10	-	3	-	-	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	10	-	2	-	-	ns

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

Low-ohmic single-pole double-throw analog switch



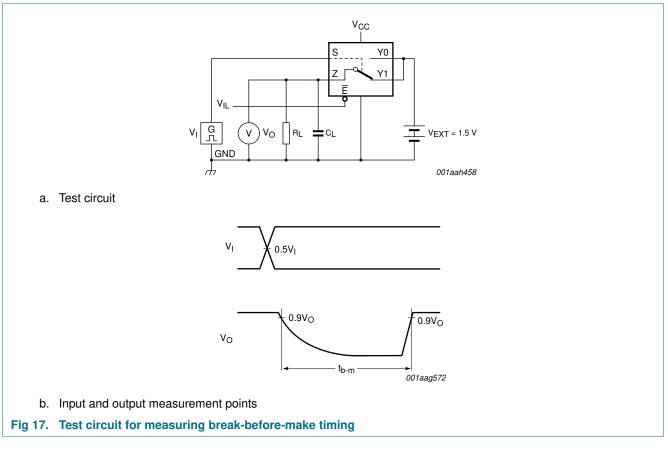
### 12.1 Waveform and test circuits

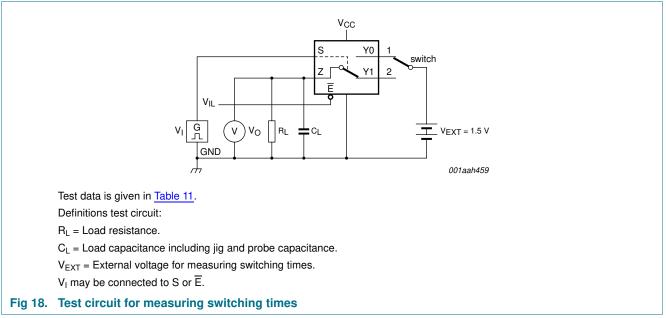
### Table 10. Measurement points

Supply voltage	Input	Output
V <sub>cc</sub>	V <sub>M</sub>	V <sub>X</sub>
1.4 V to 4.3 V	0.5V <sub>CC</sub>	0.9V <sub>OH</sub>

# **NX3L1T53**

#### Low-ohmic single-pole double-throw analog switch





#### Table 11. Test data

Supply voltage	Input		Load		
V <sub>cc</sub>	V <sub>I</sub> t <sub>r</sub> , t <sub>f</sub>		CL	RL	
1.4 V to 4.3 V	V <sub>CC</sub>	$\leq$ 2.5 ns	35 pF	50 Ω	

### 12.2 Additional dynamic characteristics

### Table 12. Additional dynamic characteristics

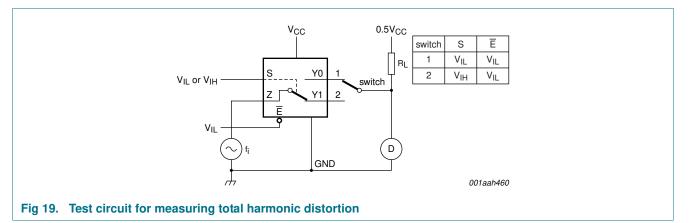
At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_I = GND$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 2.5$  ns;  $T_{amb} = 25$  °C.

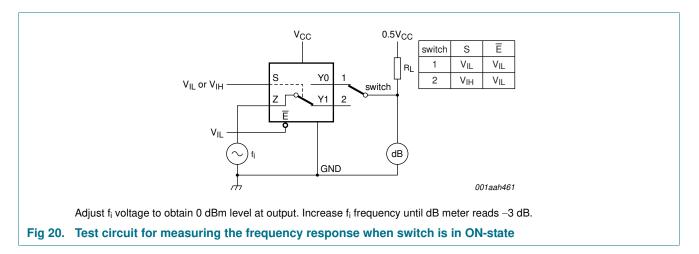
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
THD	total harmonic distortion	$f_i = 20 \text{ Hz to } 20 \text{ kHz}; \text{ R}_L = 32 \Omega; \text{ see } \frac{\text{Figure } 19}{100000000000000000000000000000000000$	<u>[1]</u>				
		V <sub>CC</sub> = 1.4 V; V <sub>I</sub> = 1 V (p-p)		-	0.15	-	%
		V <sub>CC</sub> = 1.65 V; V <sub>I</sub> = 1.2 V (p-p)		-	0.10	-	%
		V <sub>CC</sub> = 2.3 V; V <sub>I</sub> = 1.5 V (p-p)		-	0.02	-	%
		V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = 2 V (p-p)		-	0.02	-	%
		V <sub>CC</sub> = 4.3 V; V <sub>I</sub> = 2 V (p-p)		-	0.02	-	%
$f_{(-3dB)}$	–3 dB frequency response	$R_L = 50 \Omega$ ; see Figure 20	<u>[1]</u>				
		V <sub>CC</sub> = 1.4 V to 4.3 V		-	60	-	MHz
$\alpha_{iso}$	isolation (OFF-state)	$f_i = 100 \text{ kHz}; \text{ R}_L = 50 \Omega; \text{ see } \frac{\text{Figure 21}}{100 \text{ kHz}}$	<u>[1]</u>				
		V <sub>CC</sub> = 1.4 V to 4.3 V		-	-90	-	dB
V <sub>ct</sub>	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$ ; $C_L = 50 \text{ pF}$ ; $R_L = 50 \Omega$ ; see Figure 22					
		V <sub>CC</sub> = 1.4 V to 3.6 V		-	0.2	-	V
		V <sub>CC</sub> = 3.6 V to 4.3 V		-	0.3	-	V
Xtalk	crosstalk	between switches; $f_i = 100 \text{ kHz; } R_L = 50 \Omega$ ; see <u>Figure 23</u>	<u>[1]</u>				
		V <sub>CC</sub> = 1.4 V to 4.3 V		-	-90	-	dB
Q <sub>inj</sub>	charge injection	$      f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; \\ R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure 24}}{2}      $					
		V <sub>CC</sub> = 1.5 V		-	3	-	рС
		V <sub>CC</sub> = 1.8 V		-	4	-	рС
		$V_{CC} = 2.5 V$		-	6	-	рС
		$V_{CC} = 3.3 V$		-	9	-	рС
		$V_{CC} = 4.3 V$		-	15	-	рС

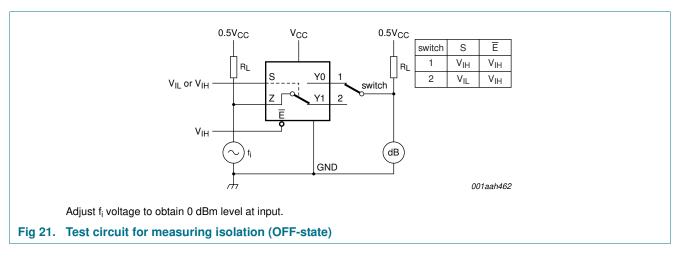
[1]  $f_i$  is biased at 0.5V<sub>CC</sub>.

### Low-ohmic single-pole double-throw analog switch

### 12.3 Test circuits

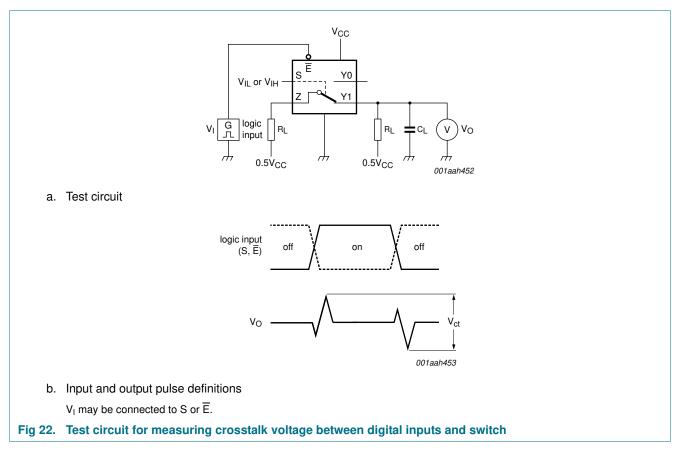


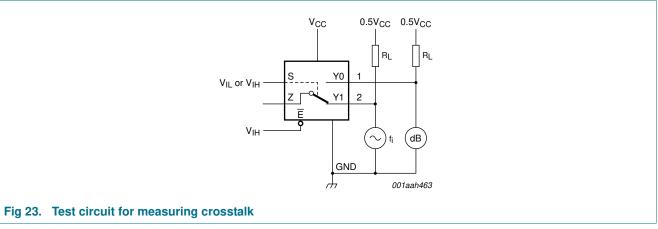




# NX3L1T53

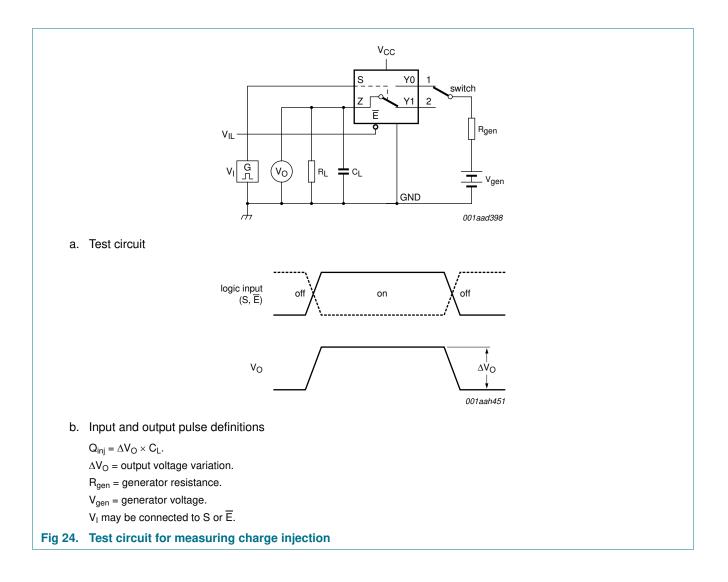
### Low-ohmic single-pole double-throw analog switch





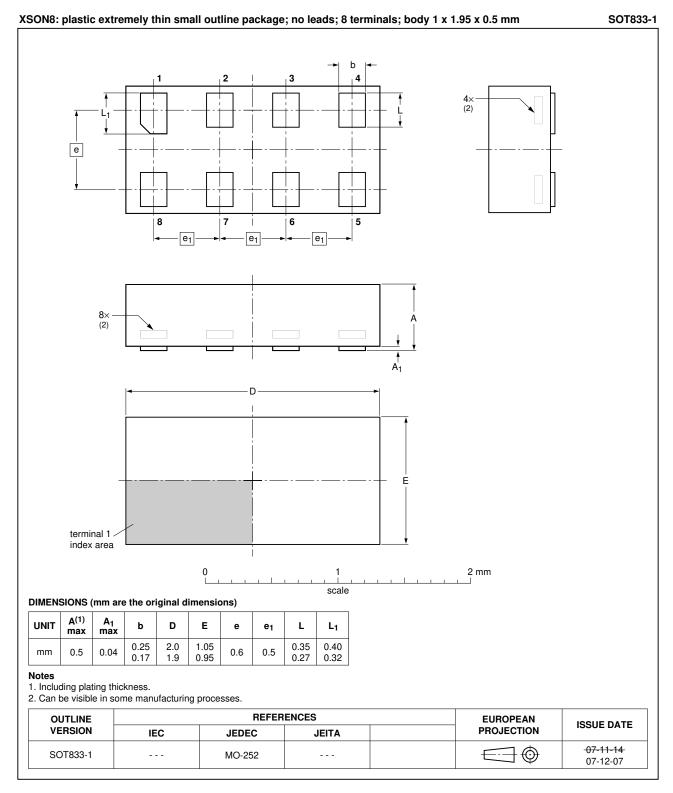
# NX3L1T53

### Low-ohmic single-pole double-throw analog switch



#### Low-ohmic single-pole double-throw analog switch

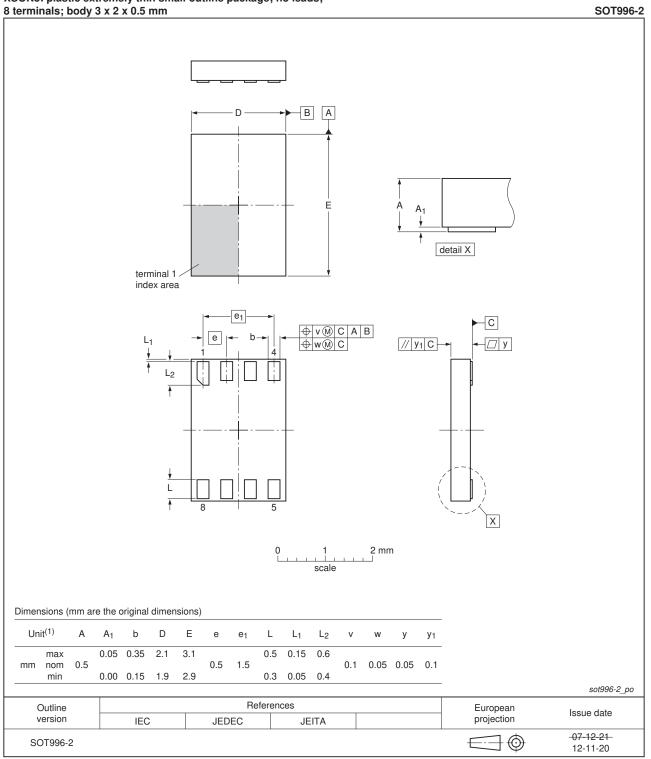
# 13. Package outline



### Fig 25. Package outline SOT833-1 (XSON8)

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Low-ohmic single-pole double-throw analog switch

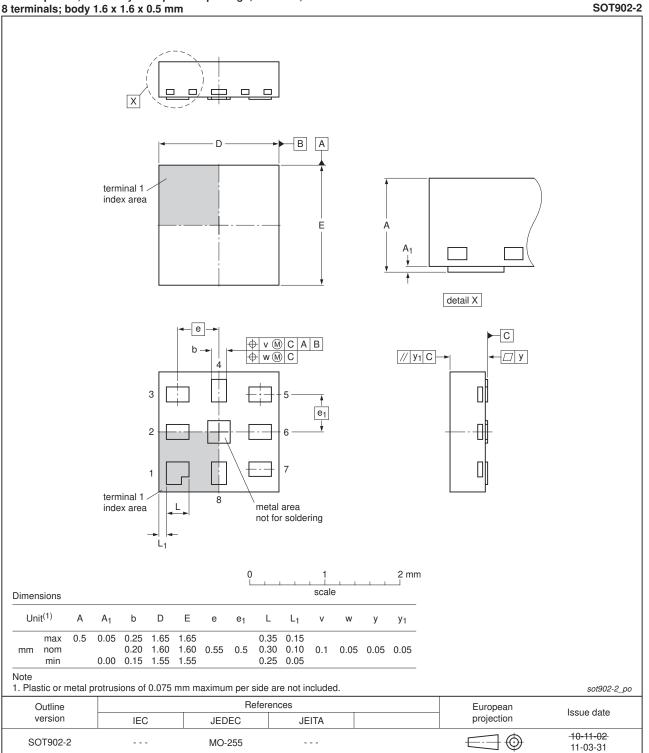


XSON8: plastic extremely thin small outline package; no leads;

Fig 26. Package outline SOT996-2 (XSON8)

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XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm

### Fig 27. Package outline SOT902-2 (XQFN8)

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### 14. Abbreviations

CDM Cha CMOS Con ESD Elec	scription arged Device Model
CMOS Con ESD Elec	arged Device Model
ESD Elec	
	mplementary Metal-Oxide Semiconductor
	ectroStatic Discharge
HBM Hun	man Body Model
MM Mac	

# **15. Revision history**

#### Table 14. Revision history **Document ID Release date** Data sheet status Change notice Supersedes NX3L1T53 v.8 20130123 Product data sheet NX3L1T53 v.7 Modifications: For type number NX3L1T53GD XSON8U has changed to XSON8. NX3L1T53 v.7 20120613 Product data sheet NX3L1T53 v.6 \_ NX3L1T53 v.6 20111108 Product data sheet NX3L1T53 v.5 \_ NX3L1T53 v.5 20110801 Product data sheet NX3L1T53 v.4 -NX3L1T53 v.4 20100324 Product data sheet NX3L1T53 v.3 -NX3L1T53 v.3 20100201 Product data sheet NX3L1T53 v.2 \_ NX3L1T53 v.2 20090414 Product data sheet NX3L1T53 v.1 -NX3L1T53 v.1 20090217 Product data sheet --

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[2] The term 'short data sheet' is explained in section "Definitions".

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